







Click here for the 3D model.

Dimensions	5
D	26.9mm MAX
L	6.35mm MIN
Н	2.54mm +/-0.127mm
F	1.397mm +/-0.25mm
Α	6.6mm MAX
В	8.64mm MAX
С	6.35mm +/-0.635mm
Е	7.62mm MAX
K	0.5mm +/-0.05mm

Packaging Specifications	
Packaging	Waffle, Box
Packaging Quantity	25

General Information			
Series	KPS-MCL Indust COG HT200C		
Style	Leaded Stacked Chip		
Description	Low Loss, Low ESR, Stacked Ceramic Chips		
Features	200C, Low ESR, High Thermal Stability, Bulk Capacitance		
RoHS	With Exemptions		
REACH	SVHC (Pb - CAS 7439-92-1)		
SCIP Number	297427bb-2a48-4853-b594-641304a2cc24		
Termination	Silver		
Lead	Straight Leads		
AEC-Q200	No		
Notes	Number of chips in this stack: 10.		

KPS-MCL Indust COG HT200C, Ceramic, 0.047 uF, 10%, 2000 VDC, COG

Specifications				
Capacitance	0.047 uF			
Capacitance Tolerance	10%			
Voltage DC	2000 VDC			
Dielectric Withstanding Voltage	2400 VDC			
Temperature Range	-55/+200°C			
Temperature Coefficient	COG			
Dissipation Factor	0.1% 1 kHz 25C			
Aging Rate	0% Loss/Decade Hour			
Insulation Resistance	21.28 GOhms			

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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